



INFORMATION DISCLOSURE STATEMENT

Applicant : MATSUMURA, et al.
App. No : 10/678,855
Filed : October 3, 2003
For : DICING/DIE-BONDING FILM,
METHOD OF FIXING CHIPPED
WORK AND SEMICONDUCTOR
DEVICE
Examiner : Laura M. Schillinger
Art Unit : 2813

CERTIFICATE OF MAILING

I hereby certify that this correspondence and all marked attachments are being deposited with the United States Postal Service as first-class mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on

March 24, 2005

(Date)

Katsuhiro Arai, Reg. No. 43,315

Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

Enclosed for filing in the above-identified application is an Information Disclosure Statement by Applicant (PTO/SB/08 equivalent) listing eight (8) references to be considered by the Examiner. Also enclosed are seven (7) foreign patent references and/or non-patent literature as listed on the Information Disclosure Statement.

This Information Disclosure Statement is being filed before the mailing date of a final action and before the mailing of a Notice of Allowance. This Statement is accompanied by the fees set forth in 37 C.F.R. § 1.17(p). The Commissioner is hereby authorized to charge any additional fees which may be required or to credit any overpayment to Account No. 11-1410.

03/29/2005 FMETEK11 00000029 10678855

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Respectfully submitted,

KNOBBE, MARTENS, OLSON & BEAR, LLP

Dated: March 24, 2005

By:
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Registration No. 43,315
Attorney of Record
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(949) 760-0404

INFORMATION DISCLOSURE STATEMENT BY APPLICANT

(Multiple sheets used when necessary)

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SHEET 1 OF 1

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| Application No. | 10/678,855 |
| Filing Date | October 3, 2003 |
| First Named Inventor | Takeshi MATSUMURA |
| Art Unit | 2813 |
| Examiner | Laura M. Schillinger |
| Attorney Docket No. | UNI079.014AUS |

U.S. PATENT DOCUMENTS

| Examiner Initials | Cite No. | Document Number Number - Kind Code (if known) Example: 1,234,567 B1 | Publication Date MM-DD-YYYY | Name of Patentee or Applicant | Pages, Columns, Lines Where Relevant Passages or Relevant Figures Appear |
|----------------------|-------------|---|--------------------------------|-------------------------------|--|
| | 1. | 4,961,804 | 10/09/1990 | Joseph A. Aurichio | |
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FOREIGN PATENT DOCUMENTS

| Examiner Initials | Cite No. | Foreign Patent Document Country Code-Number-Kind Code Example: JP 1234567 A1 | Publication Date MM-DD-YYYY | Name of Patentee or Applicant | Pages, Columns, Lines Where Relevant Passages or Relevant Figures Appear | T ¹ |
|----------------------|-------------|--|-----------------------------------|-------------------------------|--|----------------|
| | 2. | JP 60-57642 | 04/03/1985 | Joseph A. AURICHIO | | |
| | 3. | JP 60-196955 | 10/05/1985 | Takemasa UEMURA, et al. | | |
| | 4. | JP 2-248064 | 10/03/1990 | Yuzo AKATA | | |
| | 5. | EP 0 786 802 A2 | 07/30/1997 | Norito UMEHARA, et al. | | |
| | 6. | EP 0 844 766 A2 | 12/16/1998 | Masaki TSUJIMOTO, et al. | | |
| | 7. | GB 2 340 772 A2 | 03/01/200 | Hayato NOGUCHI, et al. | | |
| | 8. | EP 1 411 547 A2 | 04/21/04 | Takashi MATSUMURA, et al. | | |

NON PATENT LITERATURE DOCUMENTS

| Examiner Initials | Cite No. | Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume-issue number(s), publisher, city and/or country where published. | T ¹ |
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Examiner Signature

Date Considered

*Examiner: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

T¹ - Place a check mark in this area when an English language Translation is attached.